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The technical content of this austriamicrosystems datasheet is still valid.

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AS3635

Xenon Flash Driver with 5V IGBT Control

1 General Description

The AS3635 is a highly integrated photoflash charger with build in IGBT driver.

A build in 5V charge-pump guaranties constant IGBT drive at any battery voltage. The build in timer turns off the charge-pump 20 seconds after charging.

In circuit fuse trimming allows to set the voltage on the photoflash capacitor to $\pm 3\%$ accuracy.

The AS3635 is available in a space-saving WL-CSP package measuring only 1.5mm x 1.5mm and operates over the -30°C to $+85^{\circ}\text{C}$ temperature range.

Warning: Lethal voltages are present on applications using AS3635! Do not operate without training to handle high voltages.



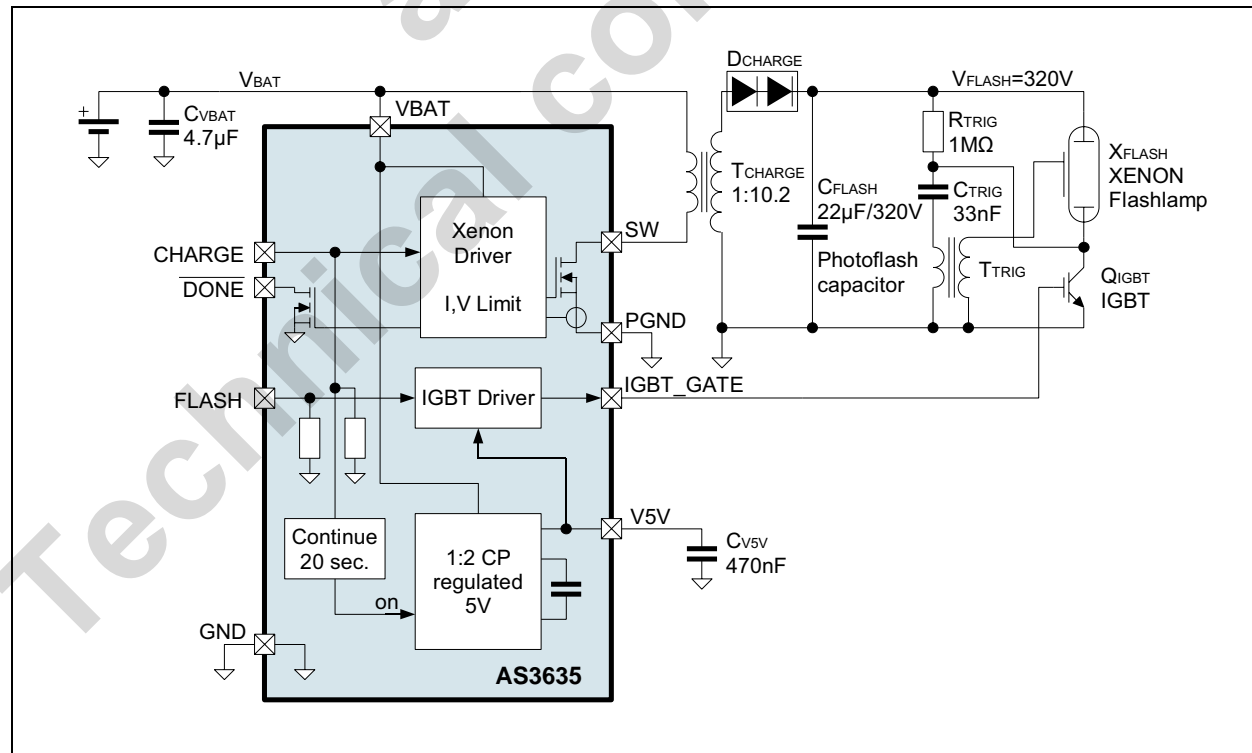
2 Key Features

- Build in 5V charge-pump for IGBT gate drive
- Photoflash voltage accuracy programmable to $\pm 3\%$ (in circuit One Time Programmable - OTP)
- Trip voltage accuracy $\pm 1.5\%$
- Small Size 1.5mm x 1.5mm x 0.6mm
- PCB: No microvias need
- Average input current $< 320\text{mA}$
- Few external components
 - No Schottky-Diode needed
 - No output voltage divider needed
- Reliable Flash on/off for IGBT timing.
- Charge time $< 4\text{sec}$ @ $V_{\text{bat}} > 2.7\text{V}$, $C_{\text{FLASH}} = 22\mu\text{F}$
- Charge complete indicator
- Undervoltage lockout
- Available in a tiny WL-CSP Package
3x3 balls 0.5mm pitch, 1.5x1.5mm package size

3 Applications

Xenon Flash driver for mobile phones, PDA and DSC

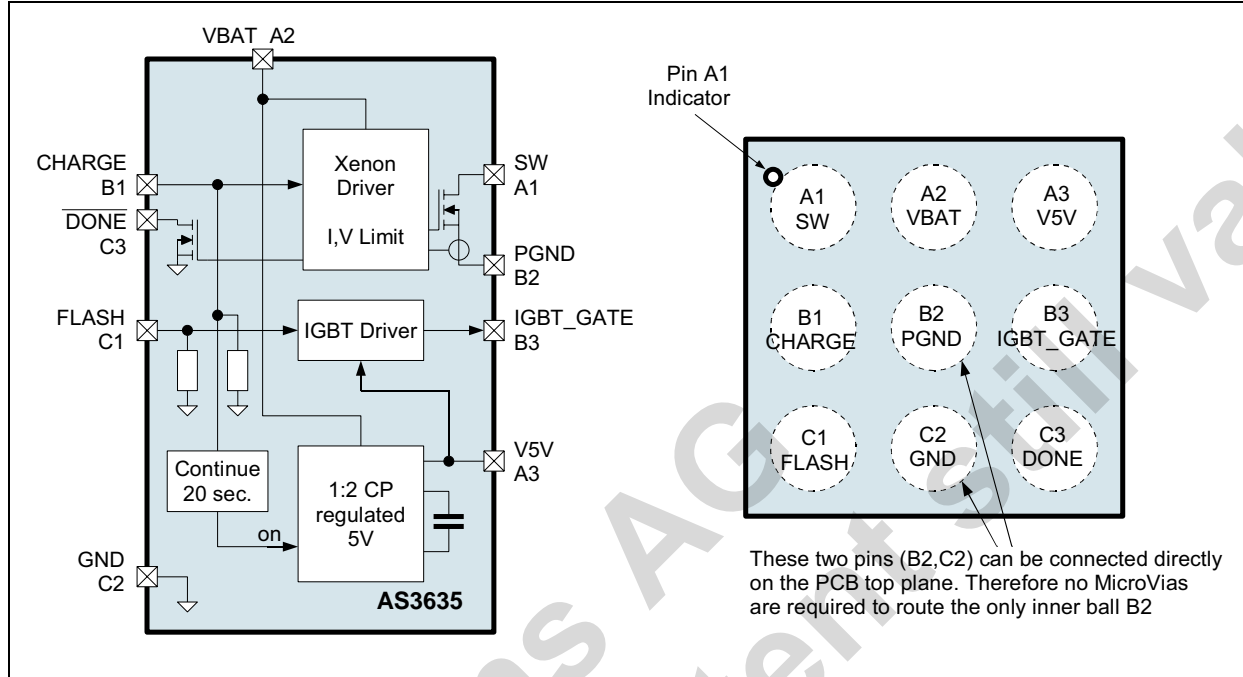
Figure 1. Typical Operating Circuit



4 Pinout

Pin Assignment

Figure 2. Pin Assignments (Top Through View)



Pin Description

Table 1. Pin Description for AS3635

Pin Number	Pin Name	Description
A1	SW	Xenon DCDC converter switching node
A2	VBAT	Positive supply voltage input
A3	V5V	5V charge pump output
B1	CHARGE	Digital input pin, active high - enables charging of photoflash capacitor
B2	PGND	Power ground - connect to ground (GND)
B3	IGBT_GATE	IGBT gate control - internally level shifted to 5V (from pin V5V)
C1	FLASH	Digital input pin, active high - Enables flash (level shifted to IGBT_GATE)
C2	GND	Signal ground - connect to ground (GND)
C3	DONE	Digital open drain output, active low - indicates end of charging

5 Absolute Maximum Ratings

Stresses beyond those listed in [Table 2](#) may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in [Table 3, "Electrical Characteristics," on page 4](#) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2. Absolute Maximum Ratings

Parameter	Min	Max	Units	Comments
VBAT, V5V to GND	-0.3	+7.0	V	
CHARGE, $\overline{\text{DONE}}$, FLASH to GND	-0.3	VBAT + 0.3	V	maximum 7.0V
IGBT_GATE to GND	-0.3	V5V + 0.3	V	
SW to PGND	-0.3	+55.0	V	
PGND to GND	0.0	0.0	V	Connect PGND to GND directly below the pad (short connection recommended)
Input Pin Current without causing latchup	-100	+100 +I _{IN}	mA	Norm: EIA/JESD78
Continuous Power Dissipation (T_A = +70°C)				
Continuous power dissipation		0.76	W	P _T ¹
Electrostatic Discharge				
ESD pins VBAT, CHARGE, $\overline{\text{DONE}}$, FLASH ²		±15000	V	Air Discharge to module; IEC 61000 -4 -2 test bench
		±8000	V	Contact Test to module; IEC 61000 -4 -2 test bench
ESD HBM pins SW, IGBT_GATE, PGND, V5V		±2000	V	Norm: MIL 883 E Method 3015
ESD CDM		±500	V	Norm: JEDEC JESD 22-C101C
ESD MM		±100	V	Norm: JEDEC JESD 22-A115-A level A
Temperature Ranges and Storage Conditions				
Storage Temperature Range	-55	+125	°C	
Humidity	5	85	%	Non condensing
Body Temperature during Soldering		+260	°C	according to IPC/JEDEC J-STD-020
Moisture Sensitivity Level (MSL)	MSL 1			Represents a max. floor life time of unlimited

1. Depending on actual PCB layout and PCB used

2. Assembled on PCB board (requires capacitor C_{VBAT}); special PCB layout (spark gaps) and external resistors required; system test for completed module (fully capsuled), no permanent interruption of operation

6 Electrical Characteristics

VVBAT = +2.51V to +5.5V, TAMB = -30°C to +85°C, unless otherwise specified. Typical values are at VVBAT = +3.6V, TAMB = +25°C, unless otherwise specified.

Table 3. Electrical Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Unit	
General Operating Conditions							
VVBAT	Supply Voltage		2.51 ¹	3.6	5.5	V	
TAMB	Operating Temperature		-30	25	85	°C	
ISHUTDOWN	Shutdown Current	CHARGE = 0, charge pump OFF, FLASH = 0 TAMB<50°C; VVBAT<3.7V		0.5	1.0	µA	
VUVLO	Undervoltage Lockout	Measured on pin VBAT	2.3		2.5	V	
VFLASH Capacitor Charger							
VTRIP	Comparator trip voltage	V(SW) - V(VBAT) in circuit adjustable with OTP. TAMB = 0°C to 50°C; only if VTRIP is trimmed by austriamicrosystems	31.9	32.4	32.9	V	
VTRIPRANGE	Programming range of VTRIP	5 bit programming 32.4V -11.2%/+10.5%; measured on pin SW Allows in-circuit trimming of the final charged voltage VFLASH on capacitor CFLASH	29.6		35.8	V	
VSW	Maximum voltage on pin SW				50	V	
ISW	Switching current limit		0.75	0.9	1.05	A	
RSW	Switch on resistance	Internal transistor between SW and PGND		0.4		Ω	
teOC_DET		end of charge comparator trigger time - see Internal Circuit on page 8	128	138	148	ns	
Charge Pump Parameters							
VV5V	5V Charge pump output voltage	5.25 > VVBAT > 2.7V	4.75	5.0	5.25	V	
		2.7V > VVBAT > 2.51V	4.3		5.25		
ICHRG_PUMP	Charge Pump Operating Current	CHARGE= 0->1->0 (20 seconds timer running ²), charge pump ON includes 48µA for internal biasing and oscillator		163		µA	
fCLK	Operating frequency			2.0		MHz	
IGBT Control - See IGBT Driver on page 13							
IBGTRISE	IGBT control voltage rise time	Pin IGBT_GATE, rise/falltime 10% - 90%, V5V=5V, TAMB=25°C, VIN=3.7V, AS3635E, load: 6.5nF (capacitor)	0.171	0.214	0.256	µs	
IBGTFALL	IGBT control voltage fall time		0.42	0.525	0.63	µs	
RIGBT_ON	IGBT switching on resistance	TAMB=-30°C to 85°C	AS3635B	30	50	60	Ω
			AS3635E	5	15	20	Ω
IIGBT_SINK	IGBT Sink Current	VIGBT_GATE below 2.3V; TAMB=-30°C to 85°C	AS3635B	10	15	20	mA
			AS3635E	52	60	70	mA
IIGBT_BOOST	IGBT Boost Current	VIGBT_GATE above 2.3V; TAMB=-30°C to 85°C	40	46	53	mA	
Digital Interface							

Table 3. Electrical Characteristics (Continued)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
V _{IH}	High Level Input Voltage	Pins CHARGE, FLASH; pin $\overline{\text{DONE}}$ in trimmode	1.26			V
V _{IL}	Low Level Input Voltage		0.0		0.54	V
V _{OL}	Low Level Output Voltage	Pin $\overline{\text{DONE}}$, I _{LOAD} =4mA			0.2	V
I _{LEAK}	Leakage current	Pin $\overline{\text{DONE}}$	-1		+1	μA
R _{PD}	Pulldown resistance to GND ³	Pins CHARGE, FLASH		52		kΩ
Recommended Transformer parameters - see Table 4, "Recommended Transformers," on page 15						
L _{PRIMARY}	Primary Inductance		6			μH
L _{LEAK}	Primary Leakage Inductance				0.4	μH
N	Turns Ratio	for V _{FLASH} =320V (final charged voltage on C _{FLASH})		10.2		
V _{ISOLATION}	Isolation Voltage		500			V
I _{SATURATION}	Primary Saturation Current		0.84			A
R _{PRIMARY}	Primary Winding Resistance				0.4	Ω
R _{SECONDARY}	Secondary Winding Resistance				60	Ω

1. Minimum V_{BAT} is set to 2.51V to allow a little margin to maximum V_{UVLO} undervoltage lockout of 2.5V.
2. Setting CHARGE=1 resets the timeout timer. Additionally the timeout timer is automatically stopped at power on reset and once it has expired.
3. Measured with V_{BAT}=3.7V, CHARGE or FLASH = 1.26V

7 Typical Operating Characteristics

VBAT = 3.6V, $T_A = +25^\circ\text{C}$ (unless otherwise specified). CFLASH=22 μF , TCHARGE Transformer = TTRN-3822, QIGBT=RJP4002ANS, ISW=750mA.

Figure 3. Charging Waveform

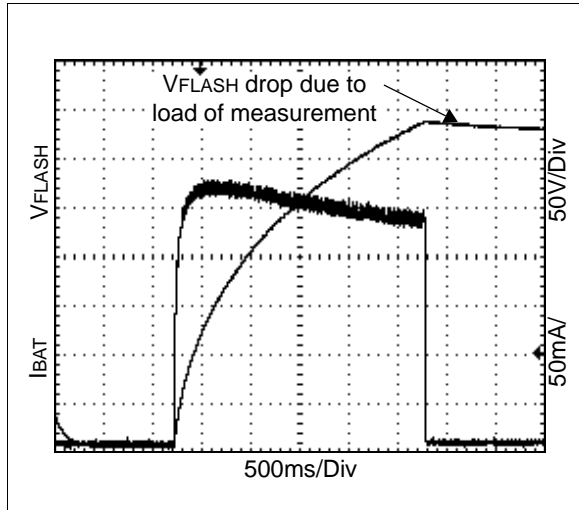


Figure 4. Charging Time vs. VBAT

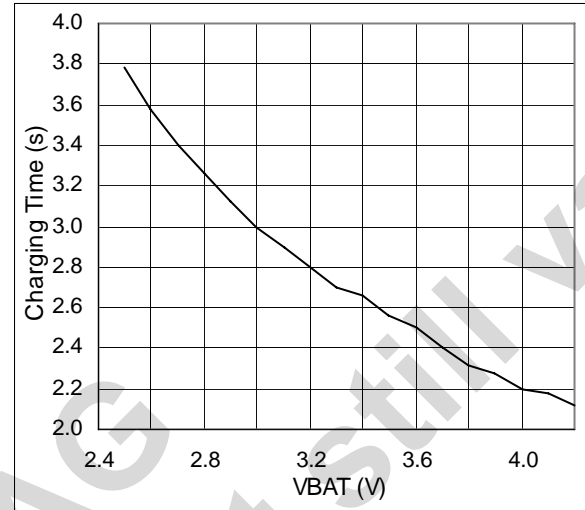


Figure 5. Charging Waveform VBAT=2.51V

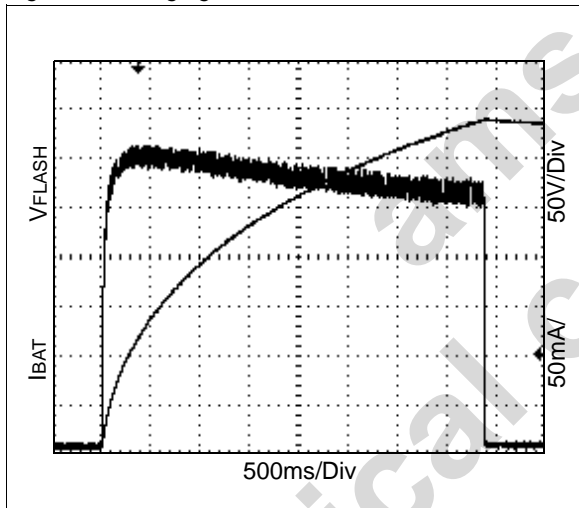


Figure 6. Charging Waveform VBAT=4.2V

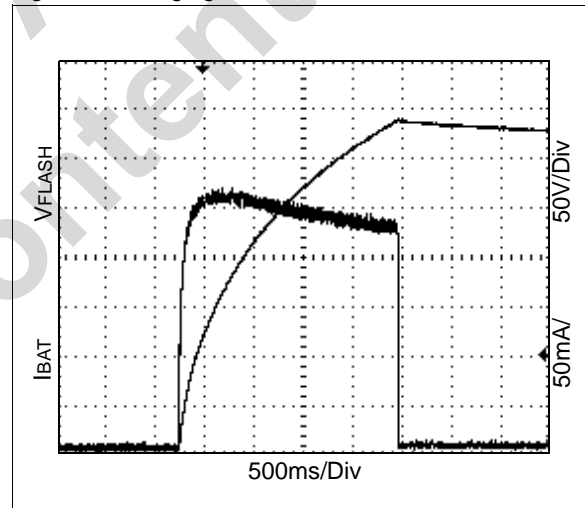


Figure 7. Efficiency vs. VFLASH

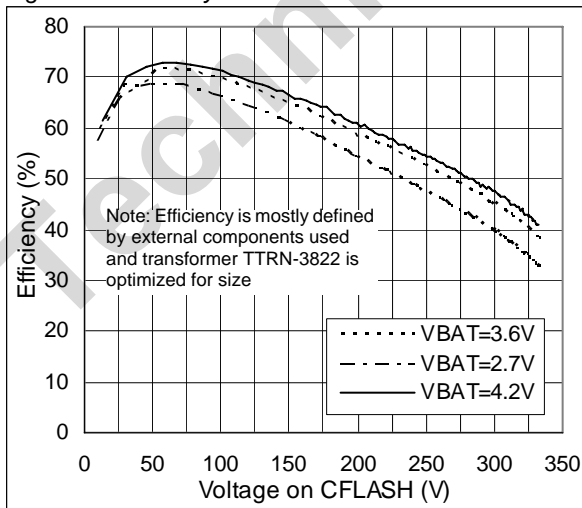


Figure 8. Efficiency vs. Charging Time

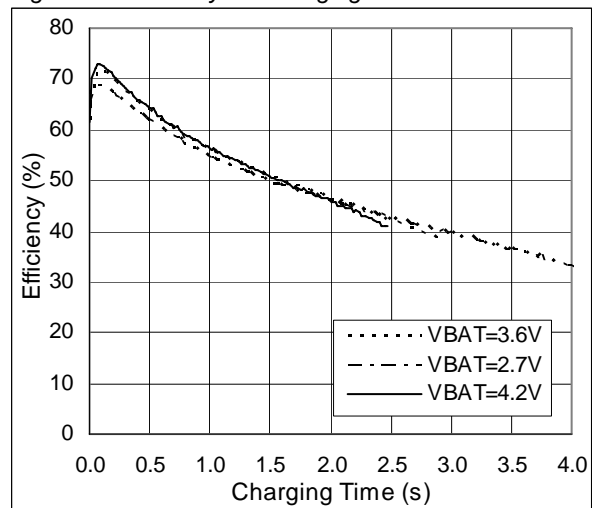


Figure 9. End of charge Voltage vs. VBAT

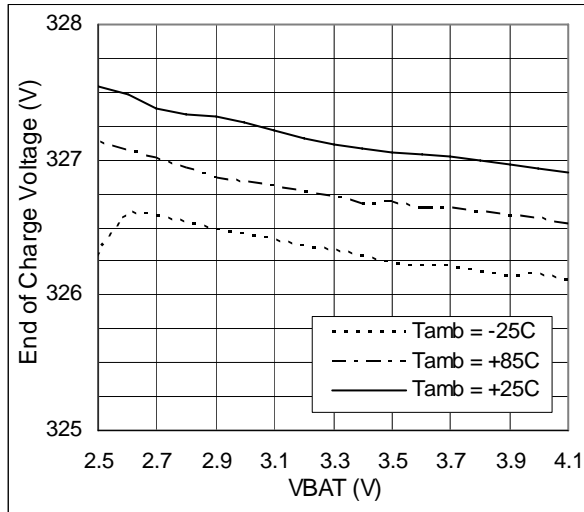


Figure 10. IGBT_GATE driving waveform

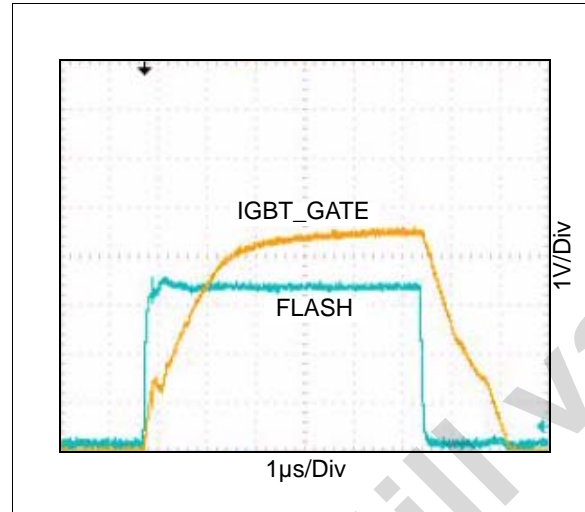


Figure 11. SW switching waveform

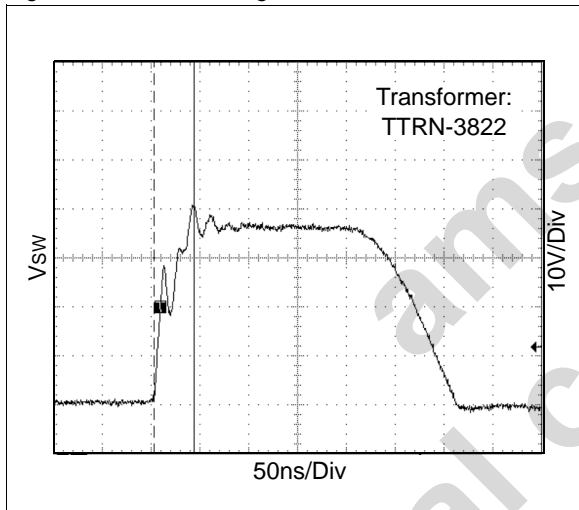


Figure 12. SW switching waveform

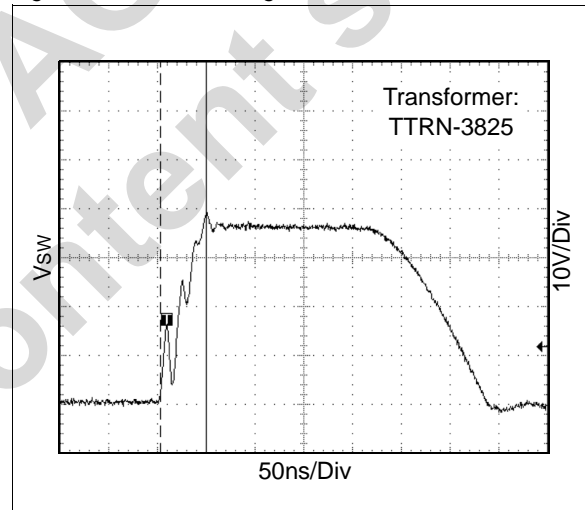


Figure 13. V5V vs. VBAT (V5V CP on)

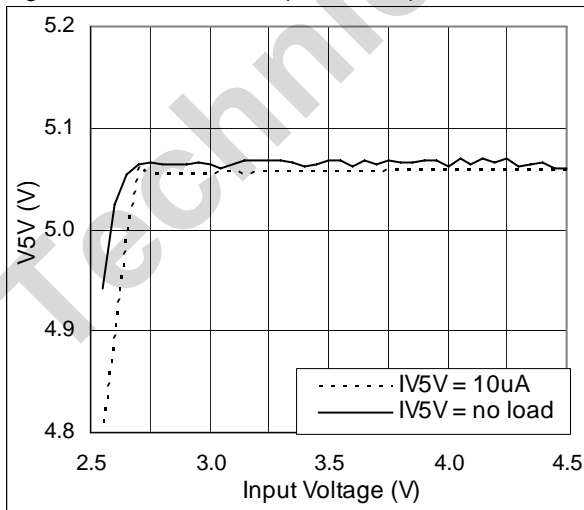
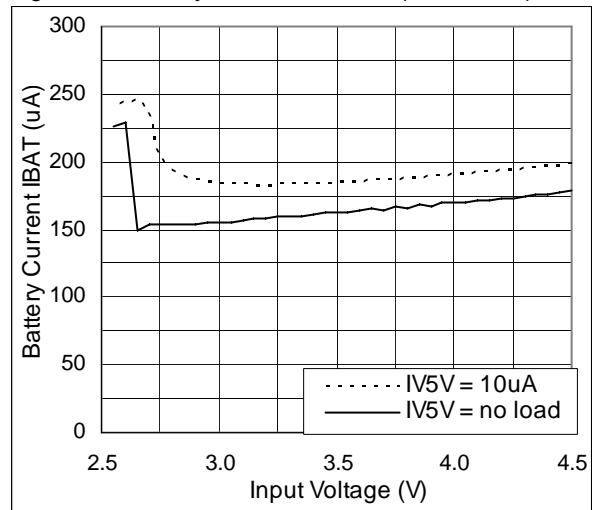


Figure 14. Battery current vs. VBAT (V5V CP on)



8 Detailed Description

The AS3635 is a photoflash capacitor charger and an integrated IGBT driver for a Xenon flash. The capacitor charger charges V_{FLASH} to the final charging voltage (e.g. 320V) and the IGBT driver starts the actual Xenon flash.

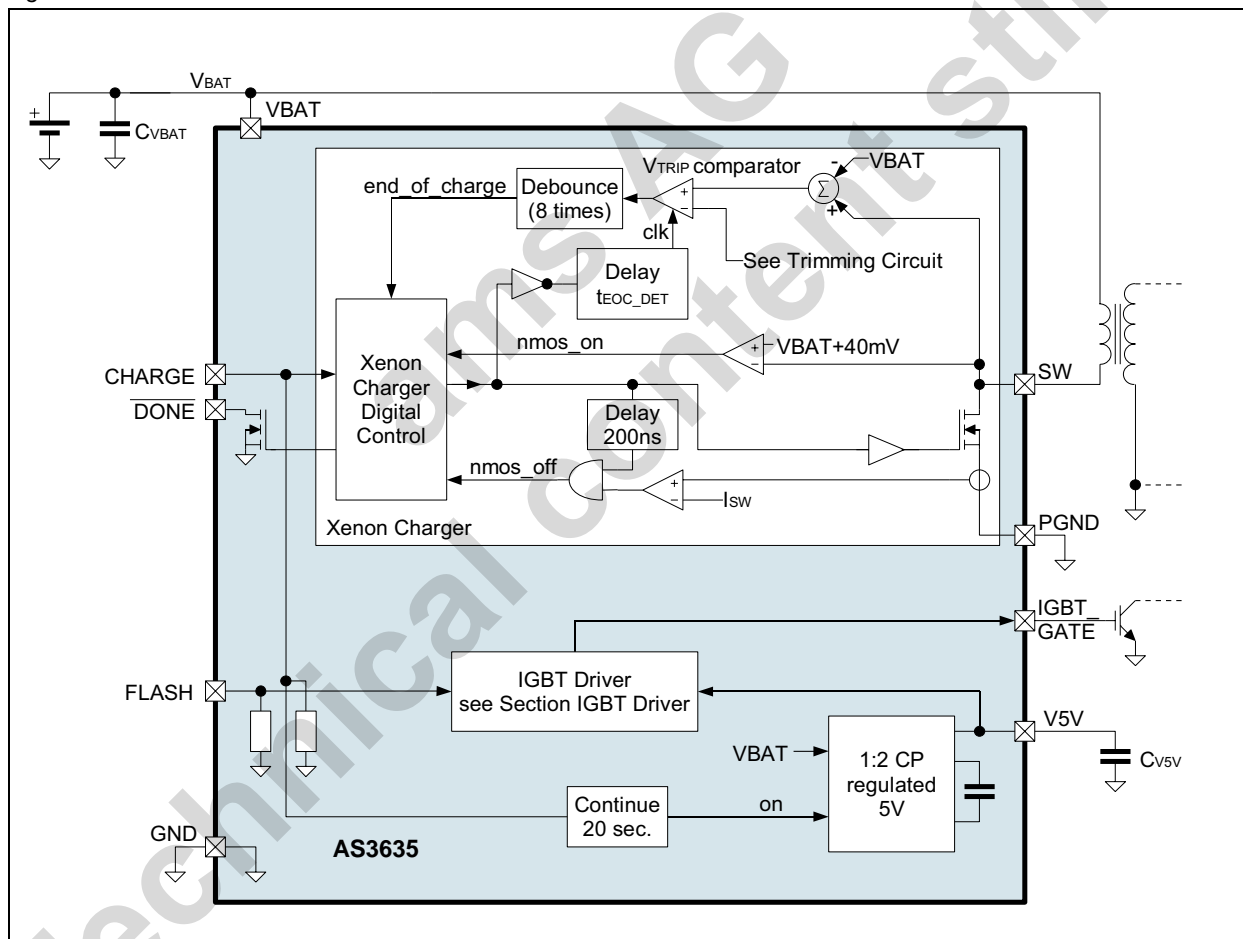
Additionally a charge pump is included to generate a stable 5V supply for accurate control of the IGBT on/off timings independent of the battery supply.

The final charged voltage (VFLASH) can be in-field trimmed to e.g. 320V with the integrated OTP (one time programmable) memory (see section [Trimming Procedure on page 12](#)). VFLASH can be exactly trimmed to the maximum allowed output voltage resulting in an improved use of the available energy in the photoflash capacitor.

Note: The AS3635 uses a WL-CSP (wafer level chip scale package) to optimize the PCB area required and minimize the module size. Therefore the actual DIE is visible (and it is not molded in plastic as for other packages like QFN or DFN) and the AS3635 is sensitive to external light. It has to be protected from direct light from the Xenon tube.

Internal Circuit

Figure 15. Internal circuit



AS3635 Operation

The AS3635 allows charging and refresh cycles under complete software control. Two typical configurations are shown in [Figure 16](#) and [Figure 17](#):

Figure 16 shows a configuration without any refresh between the pre-flash and the actual flash. Typically this is used for applications where no noise at all should be generated on the battery when the camera is performing e.g. white color balancing (between pre-flash and flash cycle).

Figure 16. AS3635 Charging Cycle without recharging between Pre-Flash and Flash

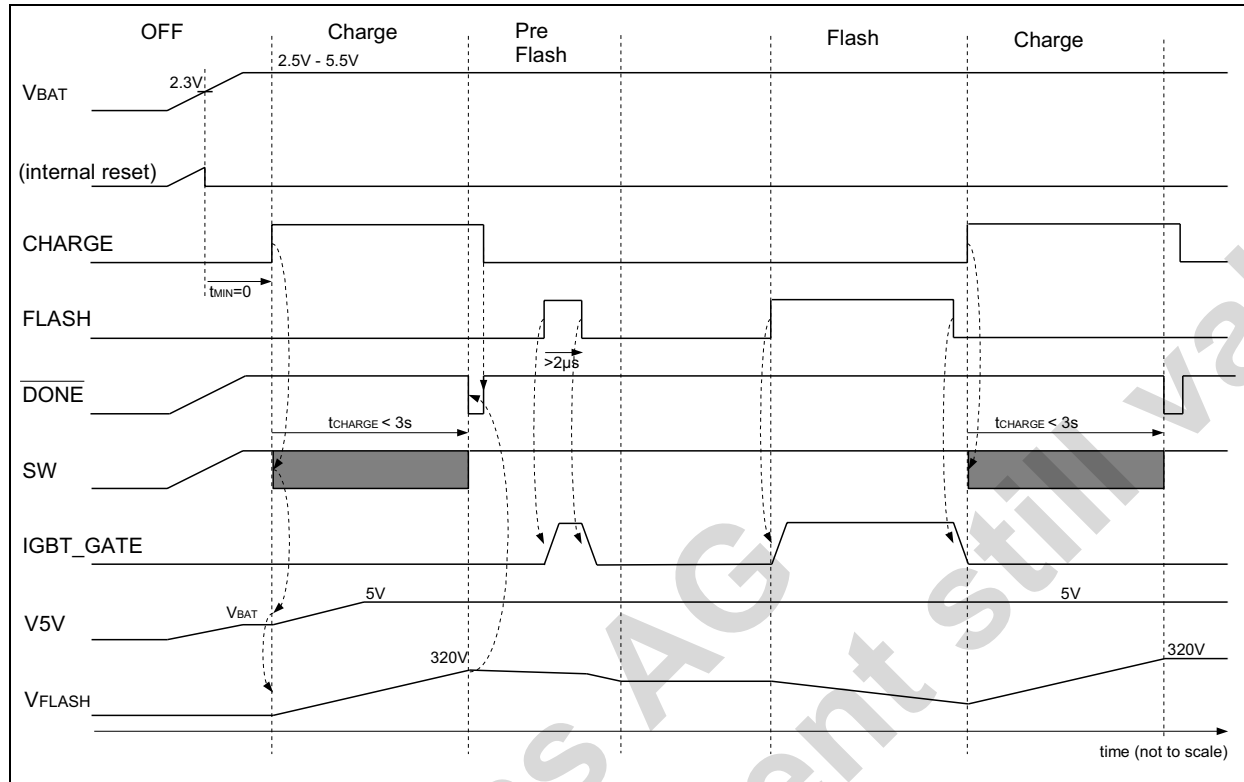
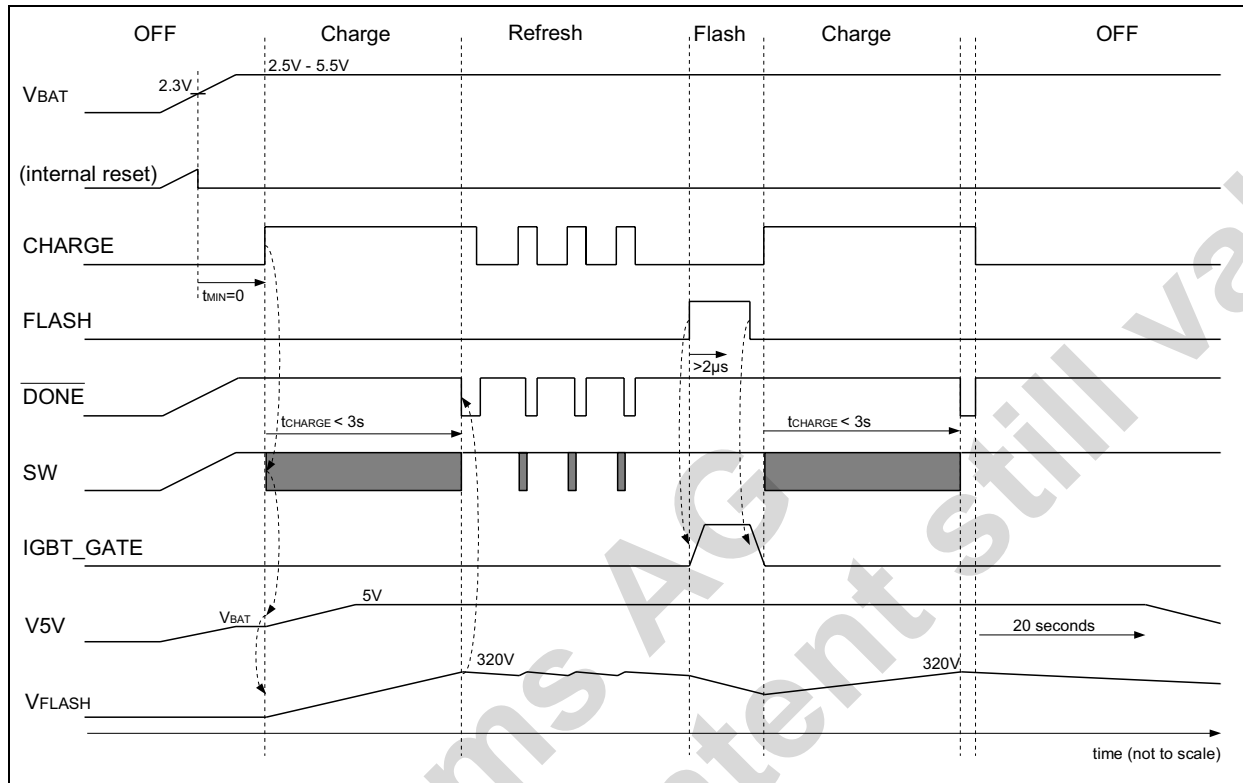


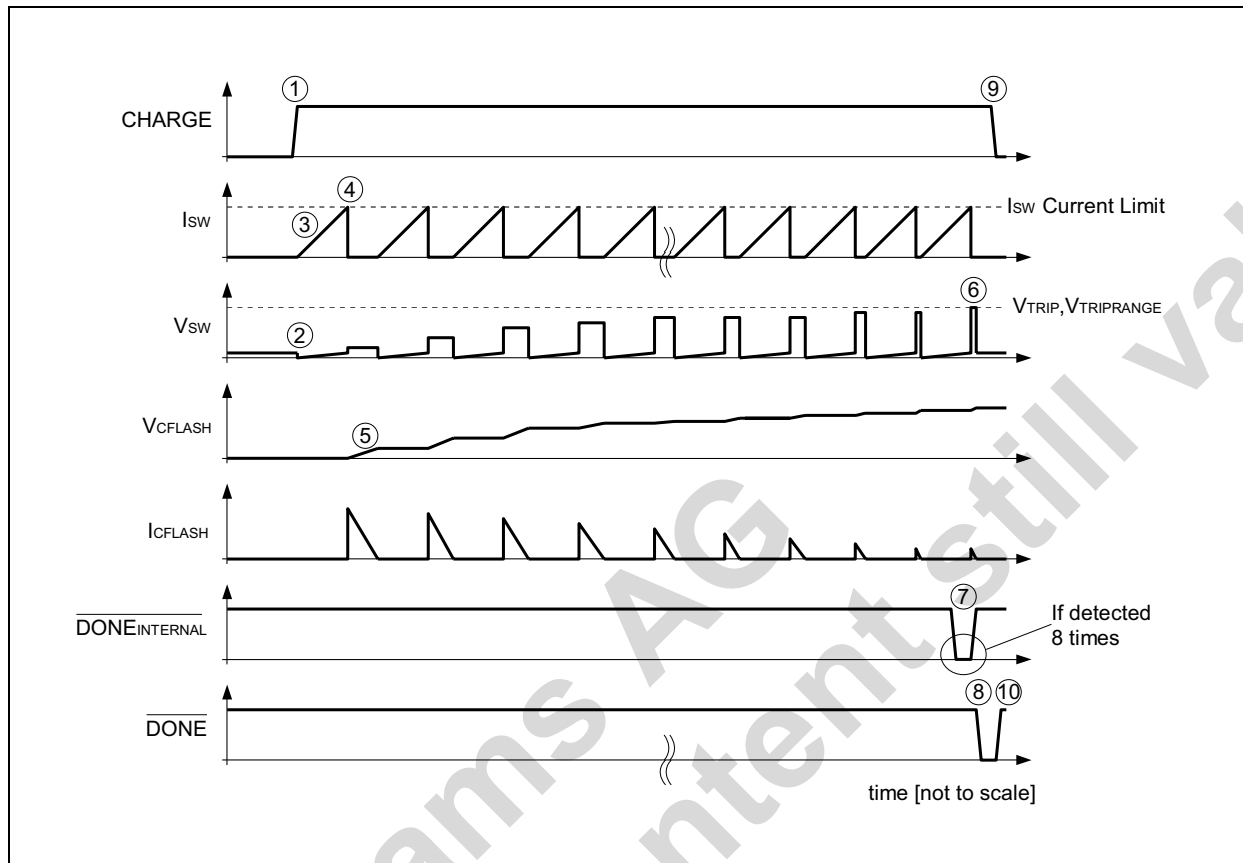
Figure 17 shows a configuration with continuous refresh of the voltage on the photoflash capacitor (VFLASH). Typically this is used in application where the maximum flash energy should be used.

Figure 17. AS3635 Charging Cycle with continuous recharging



A typical charging cycle and its voltages and current on the different pins and signals are shown in [Figure 18](#):

Figure 18. AS3635 Charging Cycle Details



The input CHARGE is set to high and charging begins (1).

During a single cycle, the internal NMOS transistor connects the pin SW to PGND (2). Therefore the current I_{sw} rises (3) until it reaches I_{sw} current limit (4). Then the energy is transferred to the secondary side of the transformer and the voltage V_{cFLASH} on the flash capacitor C_{FLASH} rises (5).

The output voltage V_{cFLASH} gradually increases and once it hits the end of charge detection threshold (6) (detected on V_{sw} during the off time of the NMOS transistor between SW and PGND) 8 times (7)¹, \overline{DONE} is pulled low (8). When CHARGE is set to low afterwards (9), \overline{DONE} returns to high (10) finishing a full charging cycle.

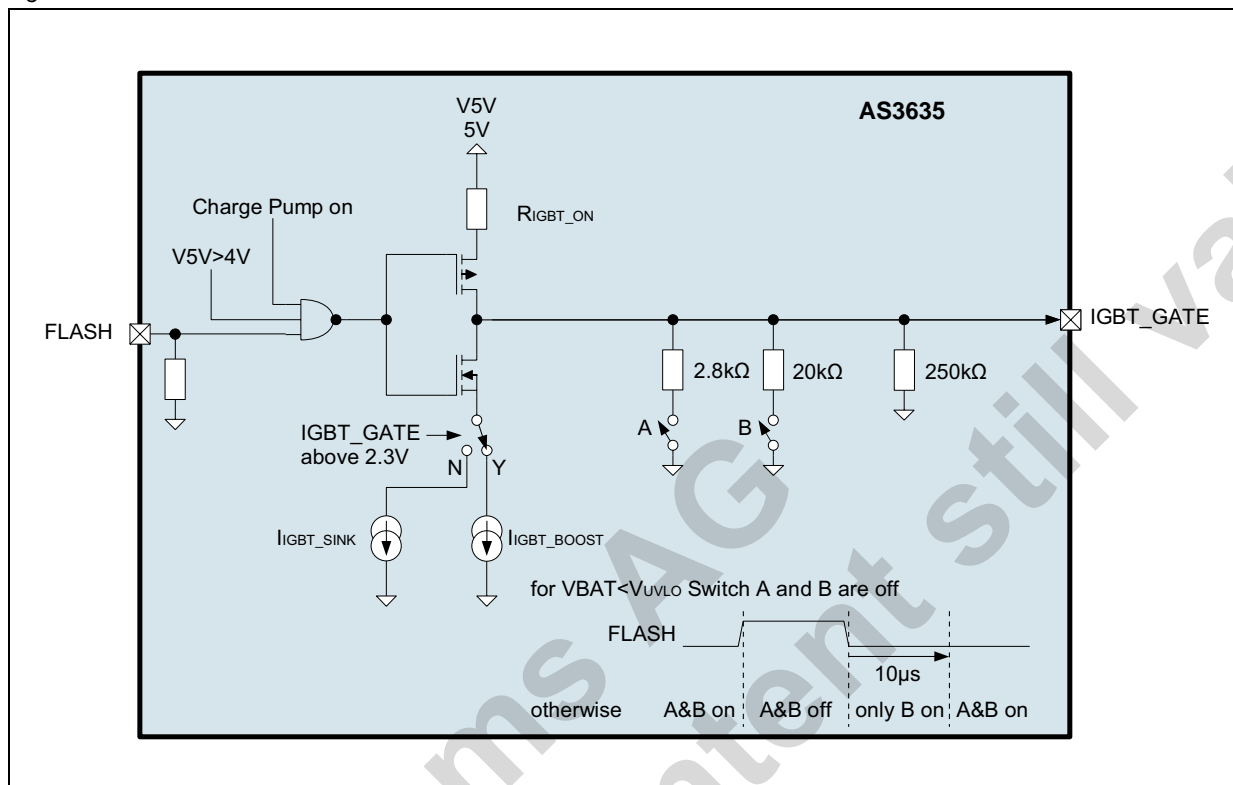
Note: For simplicity the number of actual charging cycles (NMOS SW on/off) are reduced in [Figure 18](#).

1. The 8 cycles required for actual detection of the end of charge conditions are not shown in [Figure 18](#).

IGBT Driver

The internal circuit of the IGBT driver is shown in [Figure 20](#):

Figure 20. IGBT Driver circuit



The IGBT driver is enable once the charge pump is switched on and the voltage on pin V5V has reached 4V (to guarantee at least 4V driving signal for the IGBT).

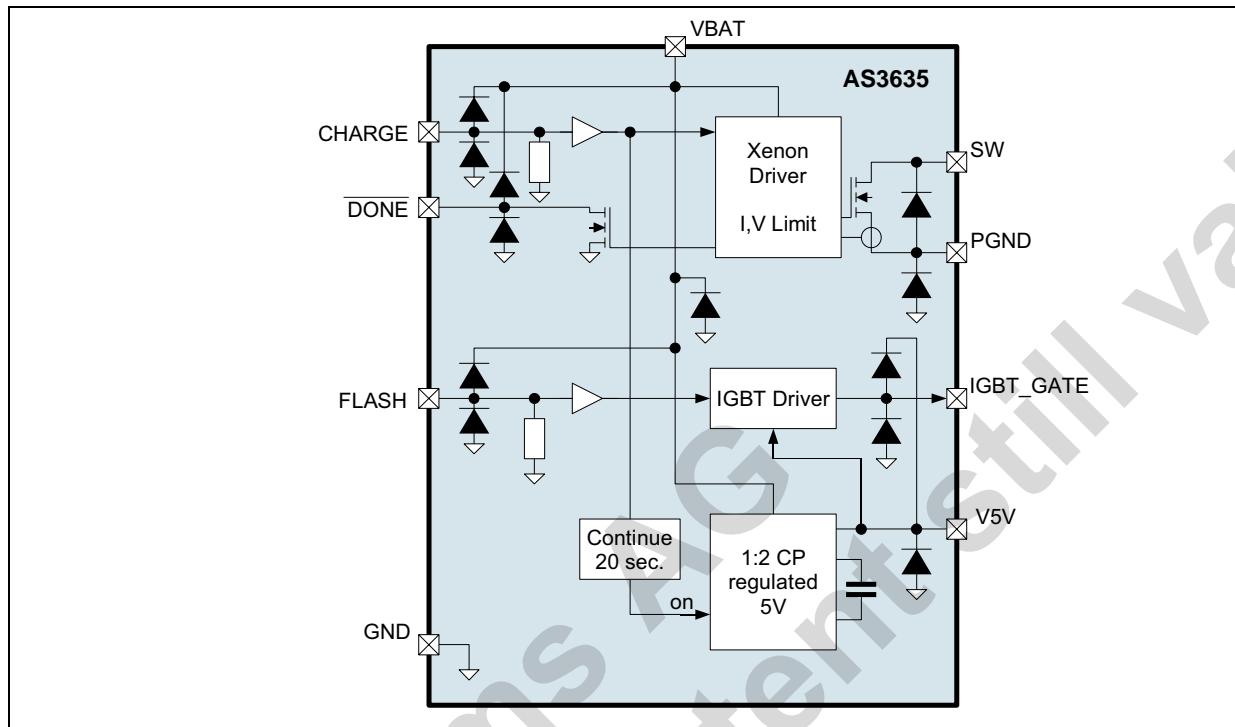
The IGBT driver includes all required resistors and pull-downs to operate the IGBT without any external circuitry³. Do not add any external pull-down resistor on pin IGBT_GATE.

3. Exception: If the Sanyo IGBT TIG058E8 is used, add a series resistor of 50Ω for the gate drive. For Renesas RJP4006AGE add a series resistor of 68Ω.

ESD Protection Diodes

The internal ESD diodes are shown in [Figure 21](#) - do not operate ESD diodes in forward direction⁴:

Figure 21. ESD Diodes



4. Exception: The diode between SW and PGND is designed to be operated in forward direction for very short pulses during charging.

9 Application Information

External Components

Transformers T_{CHARGE} and T_{TRIG}

Following transformers are recommend for the AS3635 (due to the OTP programming features see section [Trimming Procedure on page 12](#), the output voltage V_{FLASH} can be programmed):

Table 4. Recommended Transformers

Component	Part Number	N	L	Size (mm)	Manufacturer
T_{CHARGE}	C3-T2.5R	10.2	6.7 μ H	3.4x3.4x2.5	Mitsumi Electric www.mitsumi.co.jp
	TTRN-3825H	10.2	7 μ H	3.8x3.8x2.5	Tokyo Coil www.tokyo-coil.co.jp
	TTRN-3822H	10.2	7 μ H	3.8x3.8x2.2	
	TTRN-5820H	10.2	8.87 μ H	5.8x5.8x2.0	
	TTRN-0520H	10.41	8.35 μ H	5.0x5.0x2.0	
	LDT4520T-01	10.2	10 μ H	4.7x4.5x2.0	TDK www.tdk.com
	ATB322515	10.2	7 μ H	3.2x2.5x1.55 (H is max)	
T_{TRIG}	BO-02			7.3x2.5(3.5)x2.2	Tokyo Coil www.tokyo-coil.co.jp

Always check if the voltage on the pin SW does never exceed the AS3635 maximum V_{SW} (see [Table 3 on page 4](#)) specification during charging.

IGBT

As the AS3635 has an internal charge pump included, 2.5V, 2.7V and 4V IGBT can be used without limit on the supply V_{BAT} . The IGBT is used for two purposes:

1. Powering of the Xenon tube and generating together with the oscillation circuit consisting of T_{TRIG} , C_{TRIG} , R_{TRIG} a sufficiently high trigger pulse to ignite the Xenon tube (about 3.5kV) - this is accomplished by a fast rising edge of the gate of the IGBT
2. Switching off the current through the Xenon tube at the end of the flash pulse to accurately control the light emitted by the flash. To protect the IGBT the switching off falling edge voltage should be less than 400V/ μ s (measured on the emitter of the IGBT)

Both requirements are achieved with the internal driving circuit of the AS3635. Internal OTP trimming allows to adopt to different trigger coils and IGBTs.

Table 5. Recommended IGBTs

Component	Part Number	min. Drive Voltage	Size	Manufacturer
Q_{IGBT}	RJP4002ANS	2.5V	VSON-8 3 x 4.8mm	Renesas www.renesas.com
	RJP4003ANS	4.0V		
	RJP4006AGE ¹	2.7V	2.85x3.05x1.1 mm (H is max.)	
	GT8G133	4.0V	TSSOP-8 3.3 x 6.4mm	Toshiba www.semicon.toshiba.co.jp
	TIG058E8 ²	4.0V	ECH8 2.8 x 2.9mm	Sanyo www.sanyo.com

1. Add a series resistor of 68 Ω in the gate drive.
2. Add a series resistor of 47 Ω in the gate drive.

Photoflash Capacitor C_{FLASH}

The photoflash capacitor stores the energy for the flash. Its capacitance defines the maximum available energy. Using higher value capacitors as shown in Table 6 is possible, but will increase the charging time.

It is recommended to use low ESR capacitors to avoid losing power during flash (it is also possible to connect two capacitors in parallel to reduce ESR):

Table 6. Recommended Photoflash Capacitors

Component	Part Number	Capacitor	Voltage rating	Size	Manufacturer
C_{FLASH}	330FW13A6.3X20	2x13.5 μ F ¹	330V	Cylinder 2 x l=24mm, d=7mm	Rubycon www.rubycon.co.jp

1. Different capacitor values are possible to be used together with the AS3635. Lower capacitor value will reduce charging time, lower ESR capacitor will improve light output energy and reduce losses in the capacitor during the flash pulse.

Photoflash Charger rectification diode D_{CHARGE}

The rectification diode should have very low parasitic capacitance⁵ and has to withstand the operating current and reverse voltages.

Table 7. Recommended Rectification Diodes

Component	Part Number	Parasitic Capacitor	Voltage rating	Size	Manufacturer
D_{CHARGE}	FVO2R80	5pF	800V	1.25x2.5mm	Origin www.origin.co.jp
	GSD2004S	5pF / 2	2x240V	SOT-23 2.4x3.0mm	Vishay www.vishay.com
	BAS21	5pF / 2	2x250V	SC-70 2.0x2.1mm	OnSemi www.onsemi.com

Supply Capacitor C_{VBAT} and charge pump capacitor C_{V5V}

Low ESR capacitors should be used to minimize VBAT ripple. Multi-layer ceramic capacitors are recommended since they have extremely low ESR and are available in small footprints. The capacitor should be located as close to the device as possible.

X5R dielectric material is recommended due to their ability to maintain capacitance over wide voltage and temperature range.

Table 8. Recommended C_{VBAT} and C_{V5V} Capacitor

Component	Part Number	C	TC Code	Rated Voltage	Size	Manufacturer
C _{V5V}	GRM155R60J474	470nF	X5R	6.3V	0402	Murata www.murata.com
	GRM155R60J105 GRM155R61A105	1μF	X5R	6.3V 10V	0402	
C _{VBAT}	GRM188R60J475	4.7μF	X5R	6.3V	0603	

If a different output capacitor is chosen, ensure low ESR values and voltage ratings.

5. A low parasitic capacitance improves charging efficiency.

PCB Layout Guideline

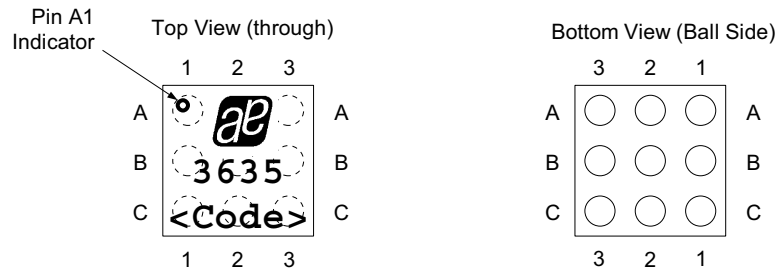
Following layout recommendations apply:

1. Keep the path (and area) of GND - CVBAT - VBAT - TCHARGE(primary) - SW - GND as short as possible to minimize the leakage inductance of TCHARGE and ensure a proper supply connection for the AS3635
2. Place CVBAT as close as possible to the AS3635.
3. Ensure wide and short PCB paths for the path GND - CFLASH - XFLASH - QIGBT - GND to allow 150A to flow during the flash pulse. Connect this GND only at a single place to the main GND plane.
4. The IGBT has two ground connections: One ground for the driving input and one ground for the power path.
5. Ensure larger spacings for all high voltage paths; check with the PCB manufacturer to ensure proper minimum spacing for 320V paths and 4kV (Xenon tube trigger pin) paths.
6. Minimize the parasitic capacitance of the PCB on the anode of DCHARGE especially to GND and VFLASH
7. See austriamicrosystems "WLP-CSP-Handling-Guidelines_1V0.pdf" for proper handling, PCB layout and soldering of the WL-CSP AS3635 device.

See austriamicrosystems demoboard layout (described in application note 'AN3635').

10 Package Drawings and Markings

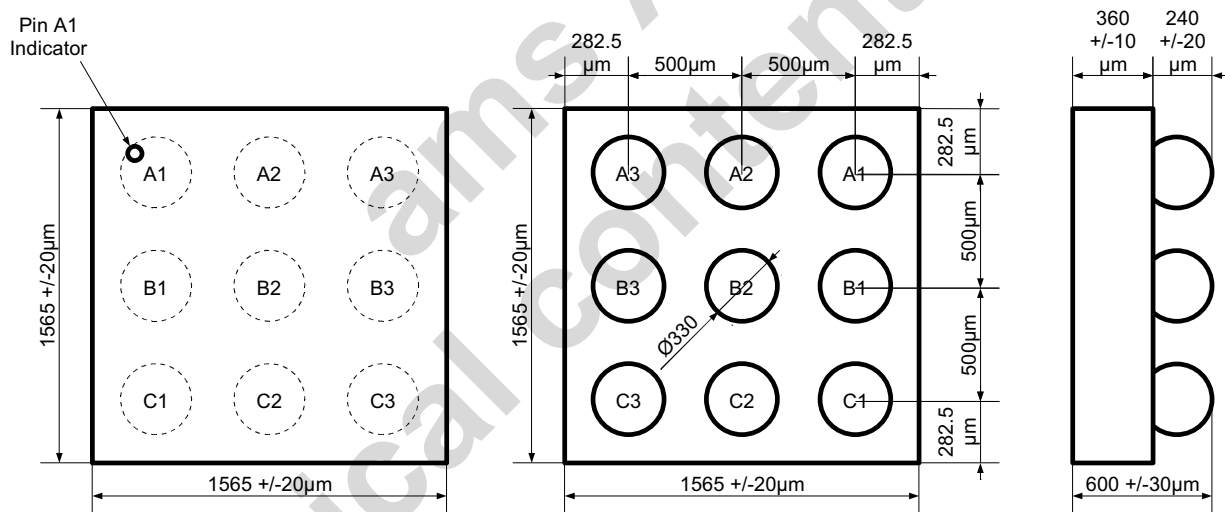
Figure 22. 9 pin WL-CSP 1.5x1.5mm Marking



Note:

- Line 1: austriamicrosystems logo
- Line 2: 3635 and version code (e.g. 'A' or 'B')
- Line 3: <Code>
Encoded Datecode (4 characters)

Figure 23. 9 pin WL-CSP 1.5x1.5mm Package Dimensions



11 Ordering Information

The devices are available as the standard products shown in [Table 9](#).

Table 9. Ordering Information

Order Code	Marking	Description	Delivery Form	Package
AS3635B-ZWLT	3635B	Xenon Flash Driver with 5V IGBT Control Isw (charging current peak) = 900mA R _{IGBT_ON} = 50Ω I _{IGBT_SINK} = 15mA I _{IGBT_BOOST} = 46mA V _{TRIP} trimmed by customer	Tape & Reel	9-pin WL-CSP (1.5mm x 1.5mm) RoHS compliant / Green / Pb-Free
AS3635E-ZWLT	3635E	Xenon Flash Driver with 5V IGBT Control Isw (charging current peak) = 900mA R _{IGBT_ON} = 15Ω I _{IGBT_SINK} = 60mA I _{IGBT_BOOST} = 46mA V _{TRIP} trimmed by customer	Tape & Reel	9-pin WL-CSP (1.5mm x 1.5mm) RoHS compliant / Green / Pb-Free

Note: All products are RoHS compliant and austriamicrosystems green.

Buy our products or get free samples online at ICdirect: <http://www.austriamicrosystems.com/ICdirect>

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For further information and requests, please contact us <mailto:sales@austriamicrosystems.com>

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Note: AS3635-ZWLT

AS3635-

B, E Version Code - see [Table 9](#) - 'Description'

Z Temperature Range: -30°C - 85°C

WL Package: Wafer Level Chip Scale Package (WL-CSP) 1.5x1.5mm

T Delivery Form: Tape & Reel

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